

## FormFactor (FORM)

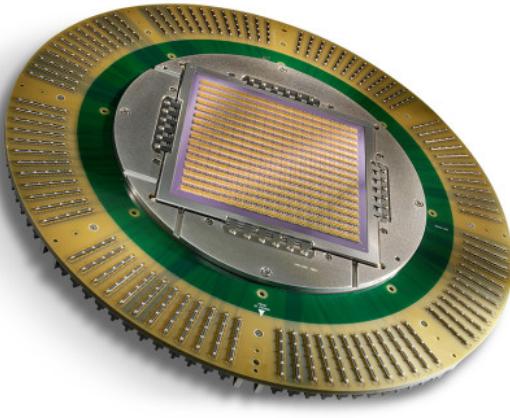
**Category:** Test Equipment (Consumable)

**Est. Price Per Unit:** \$75k - \$150k per MEMS Probe Card

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### What They Do

#### Product 101 and Where They Fit into the AI Stack



- FormFactor is the largest global player in probe cards. While they compete with Technoprobe in logic, they are the dominant leader in **memory testing** (DRAM/Flash) and maintain a diversified portfolio across the semi ecosystem.
- The key distinction is logic vs. memory:
  - Logic (Technoprobe's turf): complex, high speed, high heat. Checking calculations. CPUs, GPUs, AI accelerators.
  - Memory (FormFactor's turf): volume, repetition, parallelism. Memory chips are commodities—you want to test 500 at a time, not one.
- FormFactor builds massive MEMS probe cards that touch and test hundreds of memory chips simultaneously. This is a different engineering problem than Technoprobe's high-pin-count logic cards.
- They offer a broader product set vs. Technoprobe's depth.

### Alignment with Overall Thesis

- HBM is the tailwind. High Bandwidth Memory stacks DRAM vertically to feed AI GPUs. It's harder to test than standard memory, requires Known Good Die testing (can't stack 8 layers if the bottom one is broken), and volume is ramping as SK Hynix, Micron, Samsung feed Nvidia's demand.
- Important distinction from Camtek: Camtek uses cameras to find visible errors (bumps look straight). FormFactor uses probes to find functional errors (can the memory actually store and retrieve data). You need both.

### Business Model, Customers

- \$75k-\$150k per card. Consumable model—cards are "ink cartridges" for testing. Recurring based on touchdowns (volume).
- Core customers are memory IDMs (SK Hynix, Micron, Samsung). Also serves logic, but Technoprobe has been gaining share in high-end logic.
- More diversified than Technoprobe (memory, logic, R&D systems), which provides stability but also more exposure to memory cyclicalities.

## Comments on Team

- Founded in 1993; founder no longer in company.
- Standard US corporate structure, unlike Technoprobe's family dynasty. Led by Mike Slessor (CEO)—focused on M&A, supply chain optimization, steady diversified growth.

## Early View of Moat Hypothesis

- Memory testing dominance. Engineering for testing 500 chips simultaneously is non-trivial.
  - Breadth of portfolio makes them a one-stop shop for fabs that don't want multiple vendors.
  - Scale and supply chain leverage—larger than Technoprobe.
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## Why They're Interesting, and Why Now

- HBM is the near-term catalyst. Memory makers are scrambling to ramp production, every stack needs Known Good Die testing, and FormFactor is the incumbent.
  - We have to believe HBM shortage persists and FormFactor defends its position as testing complexity increases.
  - Diversification provides downside protection vs. pure logic plays, but also means more memory cycle exposure.
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## Key Risks

- Memory cyclical. When memory prices crash, capex freezes. FormFactor is more exposed than Technoprobe.
  - Market share loss in logic—Technoprobe has been gaining in high-end logic. FormFactor needs to defend.
  - Being the "supermarket" can mean lower margins and less pricing power than a specialist.
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## Gaps in Understanding / Key Questions

- How much of the HBM tailwind is priced in? Is memory dominance durable as HBM complexity increases?
  - What's the real market share trajectory in logic vs. Technoprobe? Ceding high-end or defending?
  - How differentiated is HBM probe card engineering vs. standard DRAM?
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## Select Financial Graphs

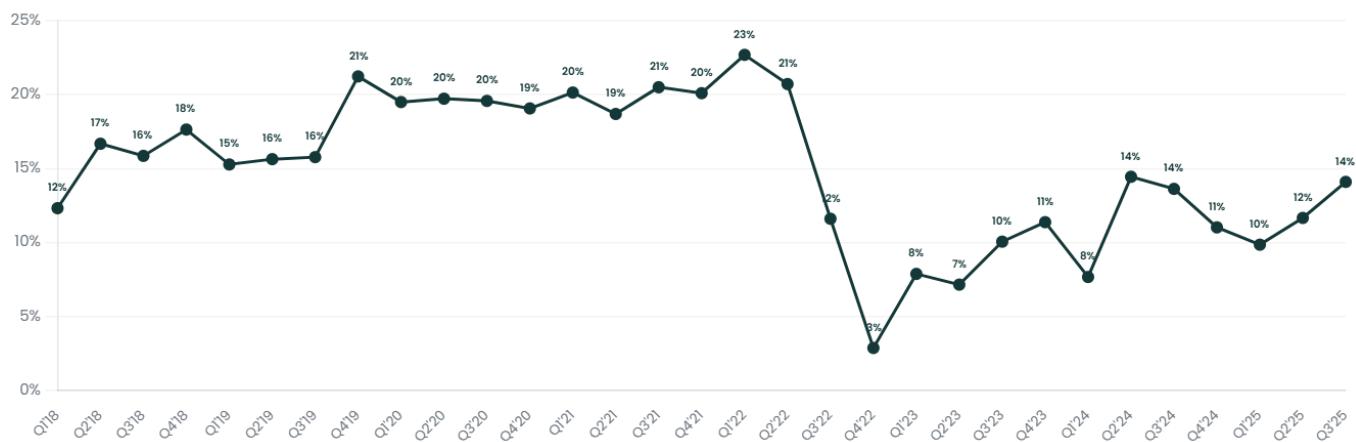
### R1: Total Revenue & YoY Growth



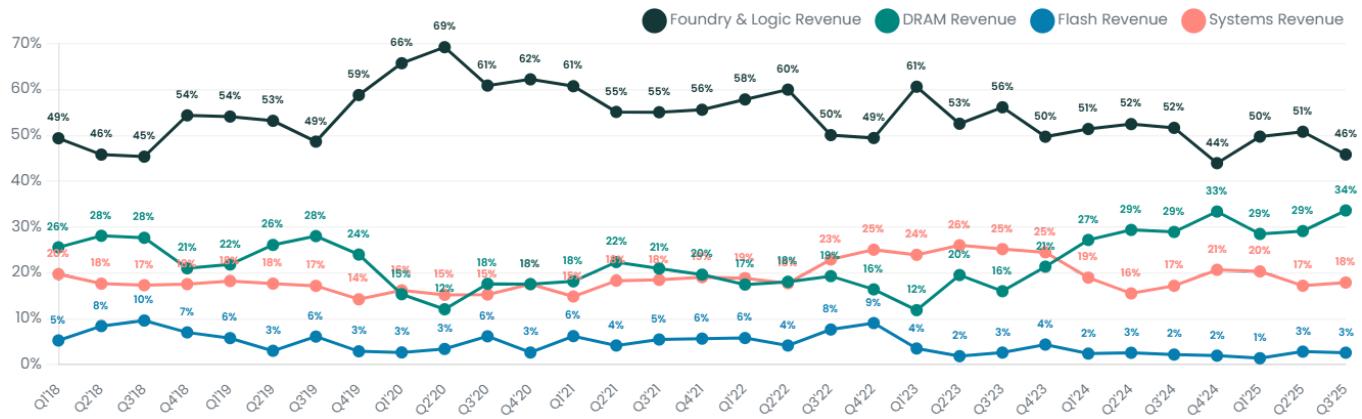
## I1: Inventory Turns



## P4: Operating Margin



## S2: End Market Mix



## V1: EV/Sales NTM



## Interesting Topics to Read

- FormFactor vs. Technoprobe competitive dynamics
- HBM probe card requirements vs. standard DRAM
- Memory testing parallelism (multi-die probing)
- Known Good Die (KGD) for HBM stacks
- Memory cycle history and probe card demand correlation